

Low Pass Filter

XLF-172H+

Mini-Circuits



THE BIG DEAL

- Match to 50Ω in the stop band, eliminates undesired reflections
- Cascadable
- Excellent stopband rejection, 47 dB typ.
- Temperature stable, up to +105°C
- Small size, 4 x 4 mm
- Protected by US Patents 8,392,495; 9,705,467, additional patent pending
- Protected by China Patent 201080014266.1
- Protected by Taiwan Patent I581494



Generic photo used for illustration purposes only CASE STYLE: DG1847

+RoHS Compliant The +Suffix identifies RoHS Compliance. See our website for methodologies and qualification:

APPLICATIONS

- Cellular, PCS
- GPS
- Radio astronomy
- Telemetry

PRODUCT OVERVIEW

Mini-Circuits' XLF-172H+ three-section reflectionless filter employs a novel filter topology which absorbs and terminates stop band signals internally rather than reflecting them back to the source. This new capability enables unique applications for filter circuits beyond those suited to traditional approaches. Traditional filters are reflective in the stop band, sending signals back to the source at 100% of the power level. These reflections interact with neighboring components and often result in intermodulation and other interferences. Reflectionless filters eliminate stop band reflections, allowing them to be paired with sensitive devices and used in applications that otherwise require circuits such as isolation amplifiers or attenuators.

KEY FEATURES

Features	Advantages
Reflectionless Technology	Reflectionless filters absorb unwanted signals, preventing reflections back to the source. This reduces gen- eration of additional unwanted signals without the need for extra components like attenuators, improving system dynamic range and saving board space.
50Ω Match in Stopband	Reflectionless filters maintain good impedance matching in the stopband, allowing for integration with high gain, wideband amplifiers without the risk of creating out-of-band instabilities.
Excellent RF Performance Repeatability	Fabricated on a GaAs process, X-series filters are inherently repeatable for large-volume production.
Excellent Stability over temperature	With ±0.3 dB variation over temperature, is ideal for use in wide temperature range applications without the need for additional temperature compensation.
Excellent Power Handling in a Compact Package	High power handling extends the usability of these filters to the transmit path for inter-stage filtering.



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ELECTRICAL SPECIFICATIONS¹ AT +25°C

Pai	rameter	F#	Frequency (MHz)	Min.	Тур.	Max.	Unit	
	Insertion Loss	DC - F1	DC - 2000	—	1.7	3.0	dB	
Passband	Frequency Cut-off	F2	2350	—	3.0	—	uв	
	VSWR	DC - F1	DC - 2000	_	1.3	—	:1	
		F3 - F3'	3600 - 3800	16	28	—		
	Rejection	F3' - F4	3800 - 11000	32	47	—	dB	
Stopband		F4 - F5	11000 - 20000	_	46	—		
Stopband	VSWR	F3 - F3'	3600 - 3800	—	1.2	—	.1	
		F3' - F4	3800 - 11000	—	1.4	—	:1	
		F4 - F5	11000 - 20000	_	1.5	—		

1. Measured on Mini-Circuits Characterization Test Board TB-952-172H+

ABSOLUTE MAXIMUM RATINGS²

Parameter	Ratings
Operating Temperature	-55°C to +105°C
Storage Temperature	-65°C to +150°C
RF Power Input, Passband (DC-F1) ²	7.9 W at 25°C
RF Power Input, Stopband (F2-F5) ³	1.58 W at 25°C

2 Passband rating derates linearly to 3.9 W at 105°C ambient

3 Stopband rating derates linearly to 0.75 W at 105 °C ambient 4 Permanent damage may occur if any of these limits are exceeded.

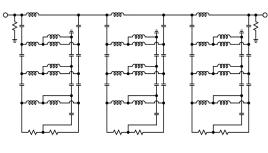
SPECIFICATION DEFINITION INSERTION LOSS (dB) F3′ DC F1F2 F3 F4 F5 FREQUENCY (MHz)



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SIMPLIFIED SCHEMATIC AND PAD DESCRIPTION



		NC	NC	NC	NC	NC	NC		
		24	23	22	21	20	19		
NC	1	•	,				-1	18	NC
GND	2	Í						[17]	GND
RF-IN	3			PAD				16	RF-OUT
GND	4			(GRO	UND)			15	GND
NC	5	-						[14]	NC
NC	6	L_					_]	13	NC
		7	8	9	10	11	12		
		NC	NC	NC	NC	NC	NC		

Function	Pad Number	Description
RF-IN	3	RF Input Pad
RF-OUT	16	RF Output Pad
GND	2,4,15,17 & paddle	Connected to ground
NC (GND Externally)	1, 5-14,18-24	No internal connection



Marking may contain other features or characters for internal lot control



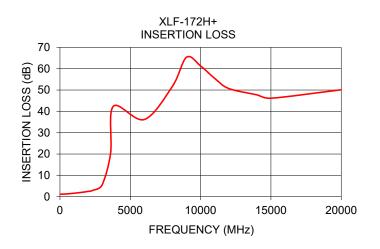
Low Pass Filter

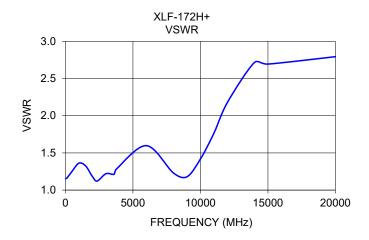


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TYPICAL PERFORMANCE DATA AT +25°C

Frequency (MHz)	Insertion Loss (dB)	VSWR (:1)
10	1.15	1.16
100	1.16	1.16
500	1.30	1.26
1000	1.61	1.36
1500	1.98	1.32
2000	2.45	1.18
2350	2.99	1.12
3000	5.58	1.22
3600	20.35	1.21
3800	42.42	1.29
6000	36.18	1.60
8000	51.77	1.23
9000	65.37	1.18
10000	61.29	1.42
11000	55.48	1.77
12000	50.73	2.18
14000	47.75	2.72
15000	46.17	2.69
20000	50.12	2.79







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ADDITIONAL DETAILED TECHNICAL INFORMATION IS AVAILABLE ON OUR DASH BOARD. TO ACCESS CLICK HERE

	Data
Performance Data and Graphs	Graphs
	S-Parameter (S2P Files) Data Set (.zip file)
Case Style	DG1847 Plastic package, exposed paddle lead finish: matte-tin
Tape & Reel Standard quantities available on reel	F68 7" reels with 20, 50, 100, 200, 500 ,1000 devices 13" reels with 2000, 3000, 4000 devices
Suggested Layout for PCB Design	PL-519
Evaluation Board	TB-952-172H+
Environmental Ratings	ENV82

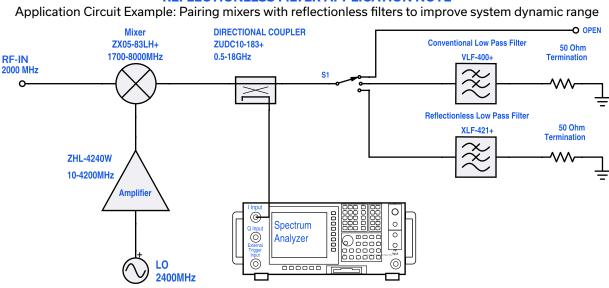
ESD RATING

Human body model (HBM): Class 1A (Pass 250V) in accordance with ANSI/ESD 5.1-2001

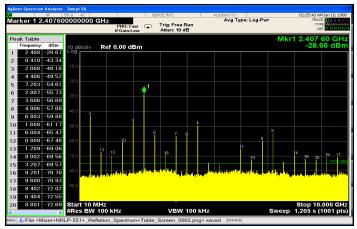


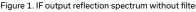
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REFLECTIONLESS FILTER APPLICATION NOTE



Test block diagram: IF output reflection spectrum with single input frequency





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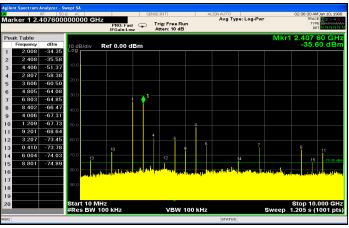


Figure 2. IF output reflection spectrum with conventional filter

An application circuit was assembled to measure the IF reflection spectrum at the output of a mixer when the mixer was paired with a conventional filter versus a reflectionless filter.

While the conventional filter reduces the reflections present when the mixer is used alone (no filter), the reflectionless filter virtually eliminates those reflections altogether.

The reflected signal at marker 1 in the figures above exhibits a reduction of more than 20 dB from -28.7 dBm to -50.3 dBm when the reflectionless filter is used as compared to the conventional filter, thus eliminating unwanted spurious mixing products and improvingsystem dynamic range.

For more information, refer to application note AN-75-007

NOTES

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

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